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<u>MOSFET</u> – Power, Single, N-Channel, DFN5/DFNW5

40 V, 1.3 mΩ**, 235 A**

NVMFS5C426N

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C426NWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Symbol	Parar	neter		Value	Unit
V _{DSS}	Drain-to-Source Voltag		40	V	
V _{GS}	Gate-to-Source Voltage	Э		±20	V
۱ _D	Continuous Drain		$T_{C} = 25^{\circ}C$	235	А
	Current R _{θJC} (Notes 1, 3)	Steady	$T_{\rm C} = 100^{\circ}{\rm C}$	166	
PD	Power Dissipation	State	T _C = 25°C	128	W
	R _{θJC} (Note 1)		$T_{\rm C} = 100^{\circ}{\rm C}$	64	
Ι _D	Continuous Drain		T _A = 25°C	41	А
	Current R _{θJA} (Notes 1, 2, 3)	Steady	$T_A = 100^{\circ}C$	29	
PD	Power Dissipation	State	T _A = 25°C	3.8	W
	R _{θJA} (Notes 1 & 2)		$T_A = 100^{\circ}C$	1.9	
I _{DM}	Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	900	А
T _J , T _{stg}	Operating Junction and	–55 to + 175	°C		
۱ _S	Source Current (Body D	122	А		
E _{AS}	Single Pulse Drain-to-S Energy (I _{L(pk)} = 19 A)	739	mJ		
ΤL	Lead Temperature for S (1/8" from case for 10 s		urposes	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Junction-to-Case - Steady State		°C/W
$R_{\theta JA}$	Junction-to-Ambient - Steady State (Note 2)	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

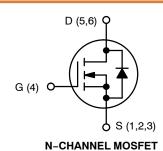
V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	1.3 m Ω @ 10 V	235 A



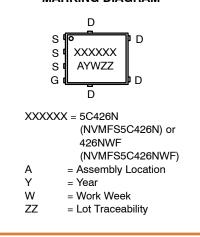
DFN5 (SO-8FL) CASE 488AA



DFNW5 (FULL-CUT SO8FL WF) CASE 507BA



MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 5.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Test Condition		Min	Тур	Max	Unit	
OFF CHAR	OFF CHARACTERISTICS							
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 μ A		40			V	
V _{(BR)DSS} / T _J	Drain-to-Source Breakdown Voltage Temperature Coefficient				9.6		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0 V, V _{DS} = 40 V	$V_{GS} = 0 V,$ $T_J = 25^{\circ}C$			10		
		v _{DS} = 40 v	T _J = 125°C			100	μΑ	
I _{GSS}	Gate-to-Source Leakage Current	V _{DS} = 0 V, V _{GS} = 20 V				100	nA	

ON CHARACTERISTICS (Note 4)

V _{GS(TH)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 170 \ \mu A$		2.5		3.5	V
$V_{GS(TH)}/T_J$	Threshold Temperature Coefficient				-8.6		mV/°C
R _{DS(on)}	Drain-to-Source On Resistance	V _{GS} = 10 V	I _D = 50 A		1.1	1.3	mΩ
9 FS	Forward Transconductance	V _{DS} =15 V, I _D = 50 A			145		S

CHARGES, CAPACITANCES & GATE RESISTANCE

C _{ISS}	Input Capacitance		4300	
C _{OSS}	Output Capacitance	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 25 V	2100	pF
C _{RSS}	Reverse Transfer Capacitance		59	
Q _{G(TOT)}	Total Gate Charge	V_{GS} = 10 V, V_{DS} = 20 V; I_{D} = 50 A	65	
Q _{G(TH)}	Threshold Gate Charge		13	nC
Q _{GS}	Gate-to-Source Charge		20	nc
Q _{GD}	Gate-to-Drain Charge	V _{GS} = 10 V, V _{DS} = 20 V; I _D = 50 A	12	
V _{GP}	Plateau Voltage		4.7	V

SWITCHING CHARACTERISTICS (Note 5)

t _{d(ON)}	Turn-On Delay Time		15	
t _r	Rise Time	V _{GS} = 10 V, V _{DS} = 20 V,	47	20
t _{d(OFF)}	Turn-Off Delay Time	$I_{\rm D} = 50 \text{ A}, \text{ R}_{\rm G} = 2.5 \Omega$	36	ns
t _f	Fall Time		9.0	

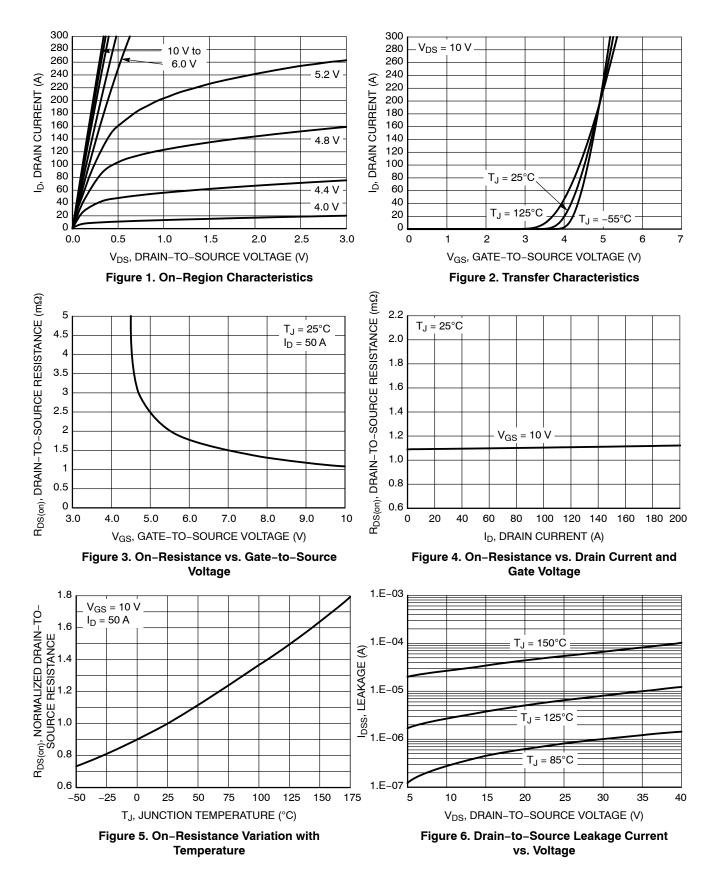
DRAIN-SOURCE DIODE CHARACTERISTICS

V _{SD}	Forward Diode Voltage	V _{GS} = 0 V, I _S = 50 A	$T_J = 25^{\circ}C$	0.82	1.2	V
		I _S = 50 A	T _J = 125°C	0.68		v
t _{RR}	Reverse Recovery Time			63		
t _a	Charge Time	V _{GS} = 0 V, dIS/dt = 100 A/μs, I _S = 50 A		34		ns
t _b	Discharge Time			29		
Q _{RR}	Reverse Recovery Charge			92		nC

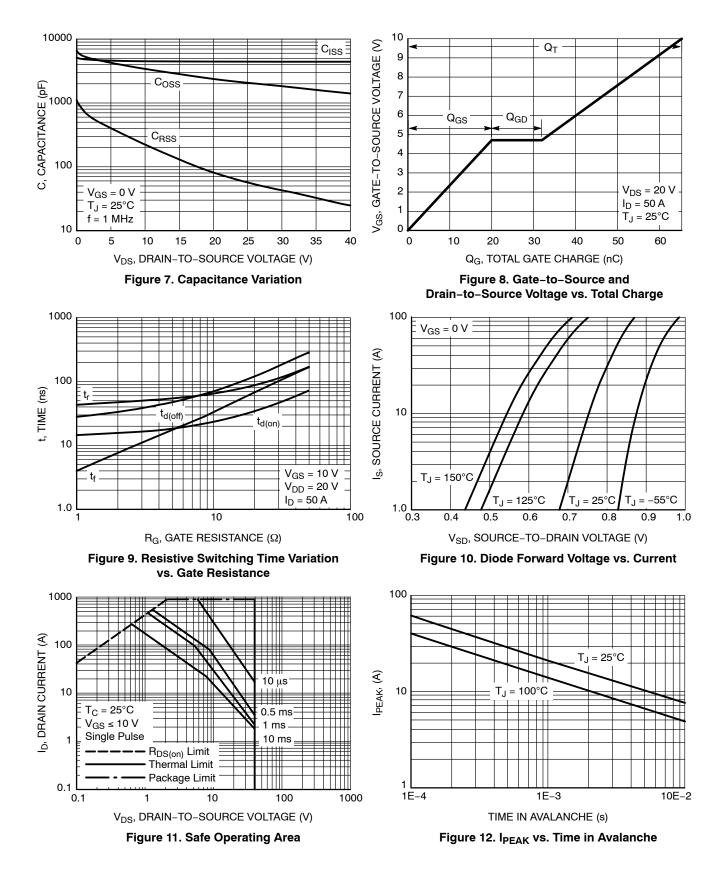
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width \leq 300 µs, duty cycle \leq 2%.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

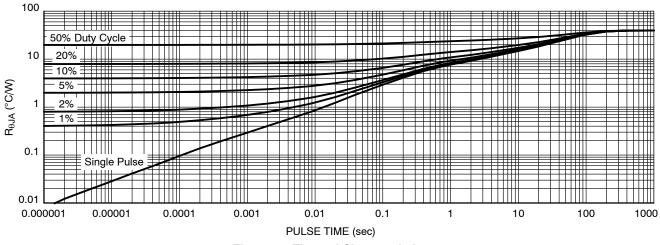


Figure 13. Thermal Characteristics

Device	Marking	Package	Shipping [†]
NVMFS5C426NT1G	5C426N	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C426NET1G	5C426N	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C426NET1G-YE	5C426N	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C426NAFT1G	5C426N	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C426NAFT1G-YE	5C426N	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C426NWFAFT1G	426NWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C426NWFET1G	426NWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

DEVICE ORDERING INFORMATION

DISCONTINUED (Note 6)

NVMFS5C426NWFT1G	426NWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C426NT3G	5C426N	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS5C426NWFT3G	426NWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel

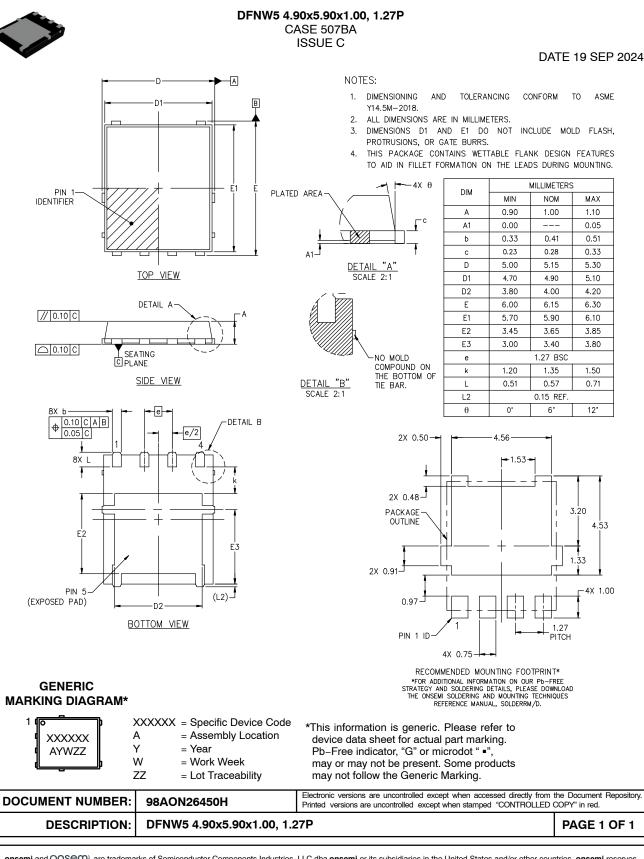
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

6. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on <u>www.onsemi.com</u>.

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